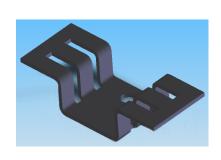
T0-220

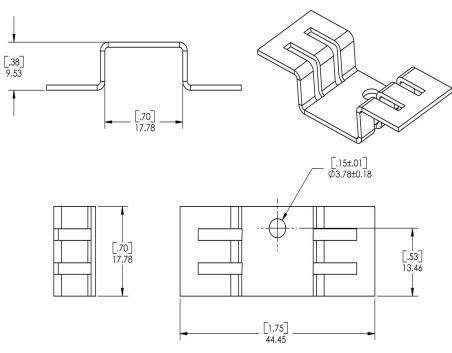
Board Level Heat Sinks



P/N: 822802B00000







PRODUCT SPECIFICATIONS

· Devices: TO-220

• Size: 17.8 x 44.5 x 9.5 mm

· Material: Aluminum, 1.0 mm Thick

• Weight: 2.5 grams

• Type: Stamped

• PCB Mounting: Device Leads

• Finish: Black Anodized

• Package: Bulk

 Accessories: Hardware & Thermal Interface Material

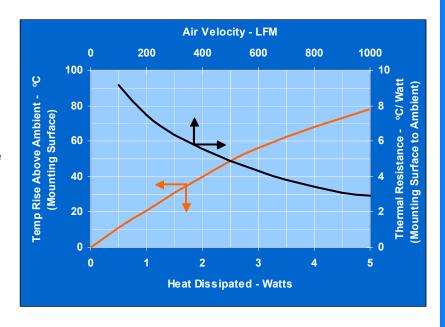
FEATURES & BENEFITS

- Hole for Device Attachment
- RoHS Compliant



CUSTOMIZED HEATSINKS

- Specialized Plating
- · Specialized Body Configurations
- Contact Applications Engineering



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